

# WSD2068DN23

#### **Dual N-Channel MOSFET**

#### **General Description**

The WSD2068DN23 is the highest performance trench N-Channel MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WSD2068DN23 meet the RoHS and Green Product requirement with full function reliability approved.

#### **Product Summery**

BV <sub>DSS</sub>	R <sub>DSON</sub>	I <sub>D</sub>
20V	15.5mΩ	7.5A

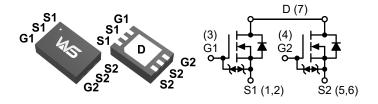
#### **Applications**

- Power Management in Notebook Computer, Portable Equipment and Battery Powered Systems.
- DC-DC Power System
- ESD:2KV

#### Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

#### **DFN2X3-6S Pin Configuration**



#### **Absolute Maximum Ratings**

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	20	V
V <sub>GS</sub>	Gate-Source Voltage	±12	V
I <sub>D</sub> @T <sub>A</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ 4.5V <sup>1</sup>	7.5	А
$I_D@T_A=70^{\circ}C$ Continuous Drain Current, $V_{GS}@4.5V^1$		6.5	А
I <sub>DM</sub>	Pulsed Drain Current <sup>2</sup>	30	A
P <sub>D</sub> @T <sub>A</sub> =25℃	P <sub>D</sub> @T <sub>A</sub> =25℃ Total Power Dissipation <sup>3</sup>		W
P <sub>D</sub> @T <sub>A</sub> =70℃	P <sub>D</sub> @T <sub>A</sub> =70°C Total Power Dissipation <sup>3</sup>		W
T <sub>STG</sub>	T <sub>STG</sub> Storage Temperature Range		°C
TJ	T <sub>J</sub> Operating Junction Temperature Range		°C

#### **Thermal Data**

Symbol	Parameter	Тур.	Max.	Unit
R <sub>eja</sub>	Thermal Resistance Junction-ambient <sup>1</sup> (Steady State)		120	°C/W
R <sub>eja</sub>	R <sub>0JA</sub> Thermal Resistance Junction-ambient <sup>1</sup> (t<10S)		83	°C/W



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## Electrical Characteristics ÁÇ/JMÁG »Ô,Á\} /^••ÁJc@\; ã^Áp[ c^åD

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage $V_{GS}$ =0V , I <sub>D</sub> =250uA		20			V	
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient Reference to $25^{\circ}$ C , I <sub>D</sub> =1mA			0.022		V/℃	
Б	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =5.5A		12	15.5	— mΩ	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =2.5V , I <sub>D</sub> =5.5A		16	20		
V <sub>GS(th)</sub>	Gate Threshold Voltage		0.3	0.7	1.0	V	
$ riangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_{D}=250$ uA		-2.32		mV/°C	
	Durin Course Lookage Current	V <sub>DS</sub> =16V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1		
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =16V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			5	μA	
I <sub>GSS</sub>	Gate-Source Leakage Current V <sub>GS</sub> =±12V , V <sub>DS</sub> =0V				±10	μA	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =10A		20		S	
R <sub>g</sub>	Gate Resistance	$V_{DS}$ =0V , $V_{GS}$ =0V , f=1MHz		11		Ω	
Qg	Total Gate Charge (4.5V)			15	20	nC	
Q <sub>gs</sub>	Gate-Source Charge			2.2			
Q <sub>gd</sub>	Gate-Drain Charge			4.2			
T <sub>d(on)</sub>	Turn-On Delay Time			148			
Tr	Rise Time $V_{DS}$ =10V , $V_{GS}$ =10V , $R_{G}$ =6 $\Omega$ ,			277			
T <sub>d(off)</sub>	Turn-Off Delay Time	I <sub>D</sub> =5A ,RL=2Ω		1616		ns	
T <sub>f</sub>	Fall Time			751		1	
C <sub>iss</sub>	Input Capacitance			1219	1350		
C <sub>oss</sub>	Output Capacitance V <sub>DS</sub> =10V , V <sub>GS</sub> =0V , f=1MHz			150		pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			123		1	

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ls	Continuous Source Current <sup>1,4</sup>				5	A
I <sub>SM</sub>	Pulsed Source Current <sup>2,4</sup>	$V_G=V_D=0V$ , Force Current			15	А
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25℃		0.76	1.3	V
t <sub>rr</sub>	Reverse Recovery Time			245		nS
Qrr	Reverse Recovery Charge	l͡⊧=5A,dl/dt=100A/μs , Tյ=25℃		1105		nC

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper, t<10sec.

2.The data tested by pulsed , pulse width  $\,\leq\,$  300us , duty cycle  $\,\leq\,$  2%

3.The power dissipation is limited by 150  $^\circ\!\!\!\mathrm{C}$  junction temperature

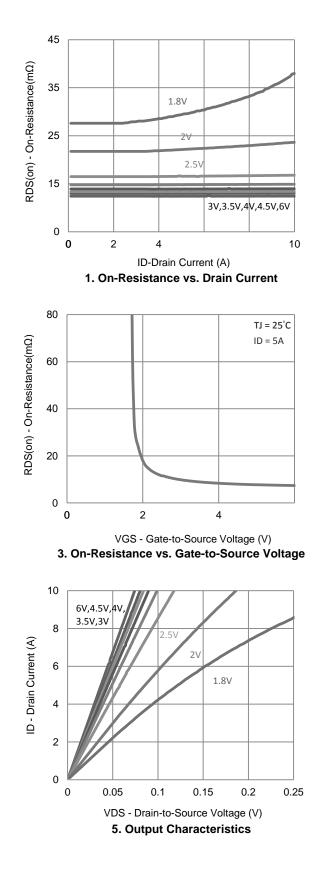
4.The data is theoretically the same as  $I_{\text{D}}$  and  $I_{\text{DM}}$  , in real applications , should be limited by total power dissipation.

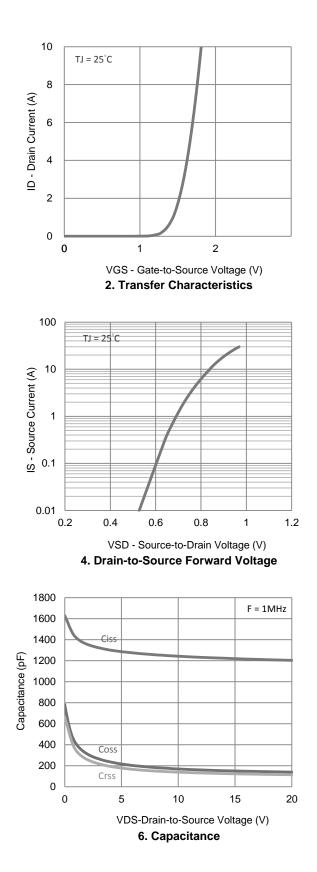




**Dual N-Channel MOSFET** 

### **Typical Characteristics**



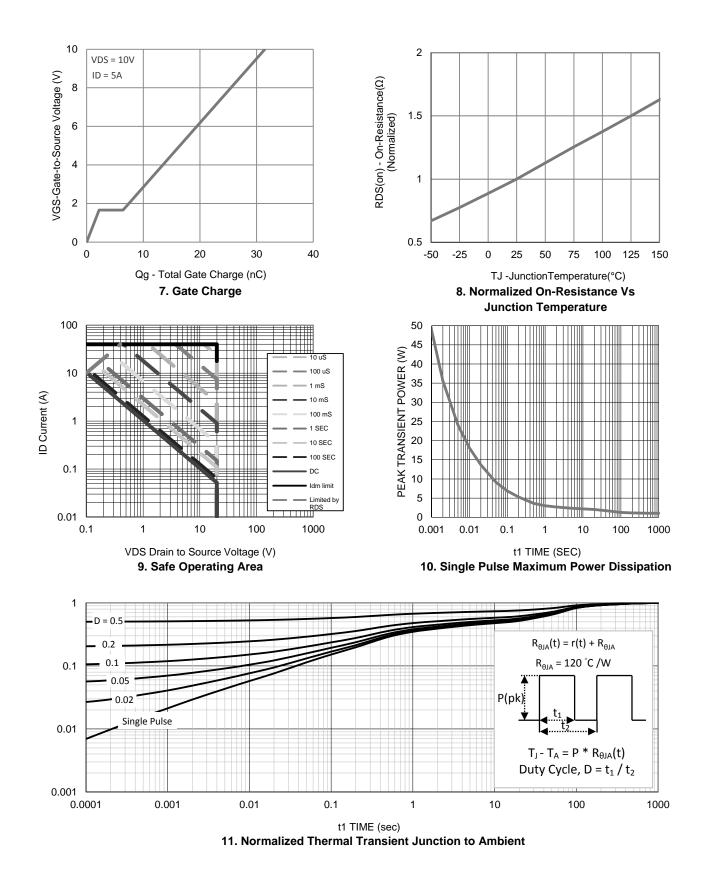




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### **Typical Characteristics (Cont.)**



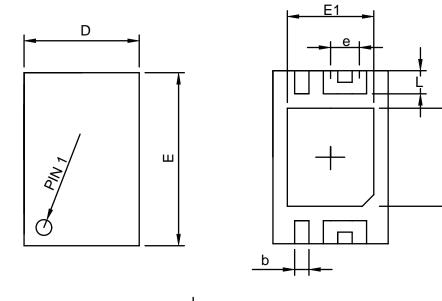


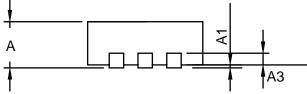
WSD2068DN23

E1

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## Packaging information





S Y	DFN2X3-6S				
M B	MILLIMETERS		INCHES		
O L	MIN.	MAX.	MIN.	MAX.	
Α	0.70	1.00	0.028	0.039	
A1	0.00	0.05	0.000	0.002	
A3	0.203 REF		0.008REF		
b	0.20	0.30	0.008	0.012	
D	1.90	2.10	0.075	0.083	
E1	1.60	1.80	0.063	0.071	
E	2.90	3.10	0.114	0.122	
D1	1.40	1.60	0.055	0.063	
е	0.50 BSC		0.02	BSC	
L	0.30	0.50	0.012	0. 20	



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